Effective February 2016 Supersedes September 2010

# BUSSMANN SERIES

## 0402ESDA-MLP **ESD** suppressor





#### **Product description**

- Ultra-low capacitance (0.05 pF) ideal for high speed data applications
- Provides Electro Static Discharge (ESD) protection with fast response time (<1 ns) allowing equipment to pass IEC 61000-4-2 Level 4 test
- Single-line, bi-directional device
- 0402 (1005 metric) compact design utilizes less board space
- · Lead free, Halogen free and RoHS compliant

#### **Applications**

- · ESD port protection for mobile/smart phones
- · Game console ESD port protection
- High speed ESD data port protection
- · Set-top-boxes
- Tablets, notebooks, netbooks, laptops
- High definition television (HDTV)
- Media players
- Digital cameras
- · Medical equipment
- Computers and peripherals ESD port protection •
- Consumer electronics

#### Ordering

· Specify part number and termination suffix (e.g. 0603ESDA-MLP1) 0603ESDA-MLP=part number, 1=Termination suffix

#### **Termination suffixes**

1 (Dip termination, Packaged: Tape and reel, 10 000 parts per 7" diameter reel)



#### 0402ESDA-MLP ESD suppressor

#### **Product specifications**

Part number⁴	Rated voltage (V <sub>DC</sub> ) maximum	Clamping voltage¹ (V) typical	Trigger voltage² (V) typical	Capacitance @ 1 MHz (pF) typical	Capacitance @ 1 MHz (pF) maximum	Attenuation change (0–6 GHz) (dB) typical	Leakage current @ 12 V <sub>DC</sub> (nA) typical	ESD capability IEC61000-4- 2 Direct discharge (kV) typical	ESD capability IEC61000-4- 2 Air discharge (kV) typical	ESD pulse withstand³ typical
0402ESDA-MLP	30	35	300	0.05	0.15	-0.2	<0.1	8	15	>1000

1. Clamping voltage: Per IEC61000-4-2, Level 4 waveform (8 kV direct 30 A) measured 30 ns after initial pulse.

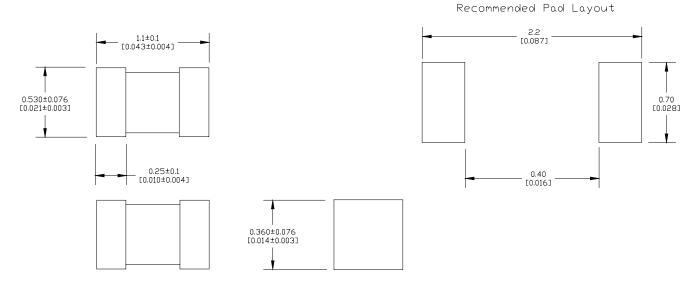
2. Trigger voltage: Trigger measurement made using Transmission Line Pulse (TLP) method.

3. Minor shifting in characteristics may be observed over multiple ESD pulses at very rapid rate.

4. Part Number Definition: 0402ESDA-MLP

0402ESDA= Product code and size -MLP= Form designation

#### Dimensions-mm [in]



#### **Design considerations**

The location in the circuit for the 0402ESDA-MLP has to be carefully determined. For better performance, the device should be placed as close to the signal input as possible and ahead of any other component. Due to the high current associated with an ESD event, it is recommended to use a "0-stub" pad design (pad directly on the signal/data line and second pad directly on common ground).

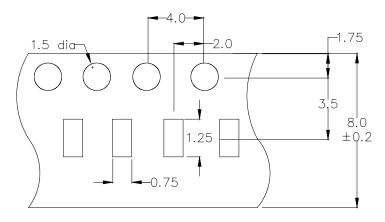
#### 0402ESDA-MLP ESD suppressor

#### **Environmental data**

Operating temperature: - 55 °C to +125 °C	
Storage temperature (component): - 55 °C to +125 °C	
Load humidity: 12 VDC per EIA/IS- 722 +85 °C, 85% relative humidity for 1000 hours	5
Thermal shock: 10 cycles, - 55 °C to +125 °C, 30 minute dwell time	
Moisture resistance: MIL-STD-202G, method 106G, 10 cycles	
Mechanical shock: EIA/IS- 722 paragraph 4.9	
Mechanical vibration: EIA/IS- 722 paragraph 4.10	
Resistance to solvent: EIA/IS- 722 paragraph 4.11	

#### **Packaging information**

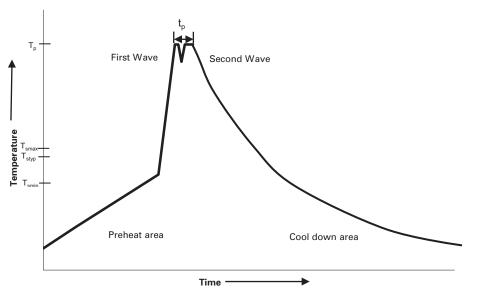
Supplied in tape-and-reel packaging, 10 000 parts per reel, 7" diameter reel.



User Direction of Feed

#### Wave solder profile

Reflow soldering not recommended



#### Reference EN 61760-1:2006

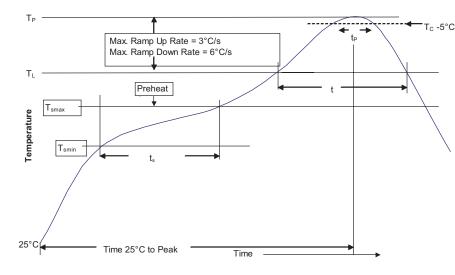
Profile Featur	e	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat	• Temperature min. (T <sub>smin</sub> )	100 °C	100 °C	
	• Temperature typ. (T <sub>styp</sub> )	120 °C	120 °C	
	• Temperature max. (T <sub>smax</sub> )	130 °C	130 °C	
	• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	70 seconds	70 seconds	
$\overline{\Delta}$ preheat to max Temperature		150 °C max.	150 °C max.	
Peak temperature (Tp)*		235 °C – 260 °C	250 °C – 260 °C	
Time at peak temperature (t <sub>p</sub> )		10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave	
Ramp-down rate	3	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	
Time 25 °C to 25	5 °C	4 minutes	4 minutes	

#### Manual solder

350 °C, 4-5 seconds (by soldering iron), generally manual hand soldering is not recommended.

#### 0402ESDA-MLP ESD suppressor

#### Solder reflow profile



### $-_{T_c - 5^{\circ}C}$ Table 1 - Standard SnPb Solder (T<sub>c</sub>)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

#### Table 2 - Lead (Pb) Free Solder (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

#### Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T <sub>smin</sub> )	100 °C		
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds	
Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>	3 °C/ Second Max.	3 °C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183 °C 60-150 Seconds	217 °C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature $(T_c)$	20 Seconds**	30 Seconds**	
Average ramp-down rate (Tp to Tsmax)	6 °C/ Second Max.	6 °C/ Second Max.	
Time 25 °C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

\* Tolerance for peak profile temperature (Tn) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

#### Eaton

Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States www.eaton.com/elx

FATON Powering Business Worldwide © 2016 Eaton All Rights Reserved Printed in USA Publication No. 4367 BU-SB101153 February 2016

Eaton is a registered trademark.

All other trademarks are property of their respective owners.